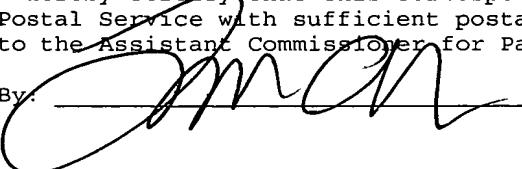


MP-IFT-699

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231

By: 

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February 10, 2003

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2-25-03
A.Wall

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Matthias Stecher et al.

Applic. No. : 10/073,847

Filed : February 11, 2002

Title : SOI Component

Examiner : Mark V. Prenty

Group Art Unit : 2822

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A M E N D M E N T

Hon. Commissioner of Patents and Trademarks,
Washington, D. C. 20231

S i r :

Responsive to the Office action dated November 8, 2002 kindly
amend the above-identified application as follows:

In the Claims:

Claim 1(amended). A semiconductor component, comprising:

a semiconductor substrate;